

C1A-T1AH up to 200°C AT Crystal 8 MHz - 24 MHz



DIMENSIONS Package: **Recommended Solder Pad:** 8,0 1,2 2,7 4,0 1,2 3,7 All dimensions in mm typical

Suitable for Downhole application SMT ceramic package height 1.75 mm Fundamental mode up to 24MHz **Extremes temperature ranges** High stability and low aging High shock and vibration resistance Hermetically sealed **Ultra low MSL Excellent solderability** Swiss made quality **Customer specification on request**

DESCRIPTION:

This quartz Crystal in SMD ceramic package has been specially designed with Micro Crystal photolitographic process for surface mount using infrared, vapor phase or epoxy technics

APPLICATIONS:

- Downhole and Well drilling equipments
- Avionics
- Airborne equipments
- Geothermal equipments

The crystals are supplied in trays (100 crystals per tray).

For pick-and-place equipment, the parts are available in 16mm tapes:

7" with 1'000 crystals 10" with 2'000 crystals

ELECTRICAL CHARACTERISTICS AT 25°C:

Frequency Range		FL	8–24	MHz
Load capacitance	1)	CL	20.0	pF
Frequency tolerance at +25°C	2)	ΔF/F	+/-50	ppm
Frequency versus temperature TD: -55 to +175°C TG: -55 to +200°C	3)	ΔF/F ₀	+/-150 +/-250	ppm
Drive level typ/max		Р	100 / 200	μW
Insulation resistance min.		R _i	500	МΩ
Aging first year max.		ΔF/F	+/-3	ppm

- 1) Other load capacitances on request.
- 2) Tighter and wider frequency tolerances on request.
- 3) Tighter thermal stability on request.

Frequency [MHz]	Rs[Ω] typ / max	C1 [fF] typ / max	Co [pF] typ
8 to < 10	100 / 150	4 / 7	2
10 to < 12	70 / 120	5/8	2.2
12 to < 16	60 / 120	6 / 10	2.5
16 to < 20	50 / 100	8 / 11	2.8
20 to ≤ 24	50 / 100	9 / 13	3.2

STANDARD FREQUENCIES:

	Frequency MHz					
8.0000	10.0000	10.1506	11.0592	12.0000	12.288	13.56
14.3181	14.7456	16.0000	16.3840	18.432	20.0000	24.0000
Other frequencies from 8 MHz up to 24 MHz on request						

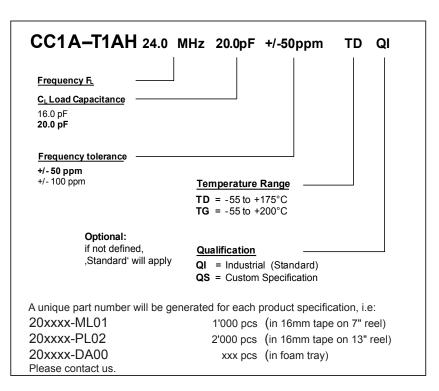
ENVIRONMENTAL CHARACTERISTICS:

	Conditions
Storage temp. range	−55 to +125°C
TD Operating temperature range	−55 to +175°C
TG Operating temperature range	−55 to +200°C
Shock resistance	10000 g, 0.3 ms, ½ sine
Vibration resistance	40 g / 10–2000 Hz

TERMINATIONS AND PROCESSING:

Туре	Termination	Processing	
CC1A-T1AH	For SMD mounting Au plated pads	Reflow soldering +260°C / 20 s max.	
Only avaible with TD temperature range CC1A-T3AH	For SMD mounting Sn/Ag/Cu plated	Reflow soldering +260°C / 20 s max.	

PRODUCT DESCRIPTION AND ORDERING INFORMATION:



All specifications subject to change without notice.



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